

# Field and Factory Programmable Spread Spectrum Clock Generator for EMI Reduction

## Features

- Wide Operating Output (SSCLK) Frequency Range
  - 3 MHz to 200 MHz
- Programmable Spread Spectrum with nominal 31.5 kHz Modulation Frequency
  - Center Spread:  $\pm 0.25\%$  to  $\pm 2.5\%$
  - Down Spread:  $-0.5\%$  to  $-5.0\%$
- Input frequency range
  - External Crystal: 8 to 30 MHz Fundamental Crystals
  - External Reference: 8 to 166 MHz Clock
- Integrated Phase-Locked Loop (PLL)
- Field Programmable devices available
- Programmable Crystal Load Capacitor Tuning Array
- Low Cycle-to-cycle Jitter
- Spread Spectrum on/off function
- Powerdown or Output Enable function
- Commercial and Industrial temperature ranges
- 3.3 V operation
- 8-pin TSSOP and SOIC packages

## Functional Description

The CY25100 is a Spread Spectrum Clock Generator (SSCG) IC used to reduce EMI found in today's high speed digital electronic systems.

The device uses a Cypress proprietary PLL and Spread Spectrum Clock (SSC) technology to synthesize and modulate the frequency of the input clock. By frequency modulating the clock, the measured EMI at the fundamental and harmonic frequencies are greatly reduced. This reduction in radiated energy can significantly reduce the cost of complying with regulatory agency (EMC) requirements and improve time-to-market without degrading system performance.

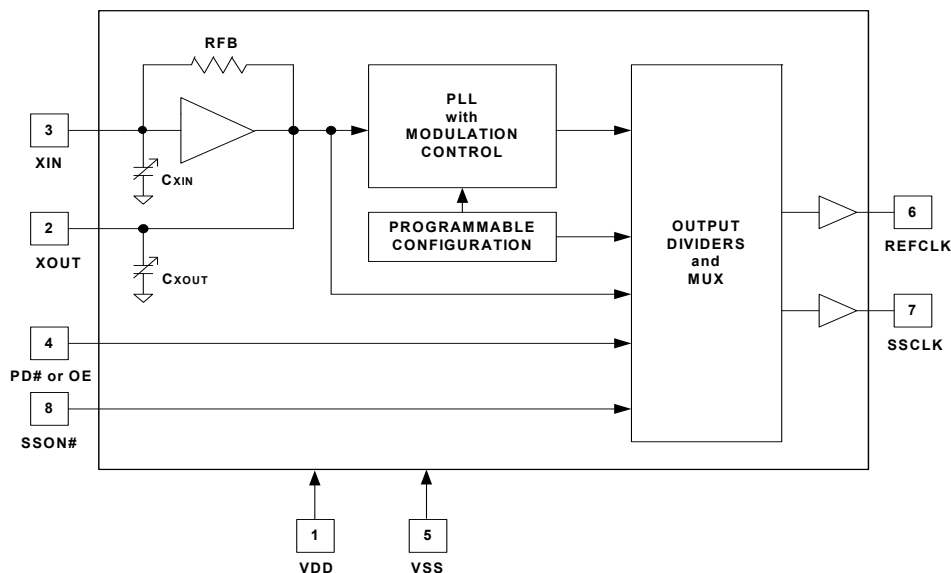
The CY25100 uses a factory or field-programmable configuration memory array to synthesize output frequency, spread percentage, crystal load capacitor, reference clock output on/off, spread spectrum on/off function, and PD#/OE options.

The spread percentage is programmed to either center spread or down spread with various spread percentages. The range for center spread is from  $\pm 0.25\%$  to  $\pm 2.50\%$ . The range for down spread is from  $-0.5\%$  to  $-5.0\%$ .

The input to the CY25100 can either be a crystal or a clock signal. The CY25100 has two clock outputs: REFCLK and SSCLK. The non-spread spectrum REFCLK output has the same frequency as the input of the CY25100.

For a complete list of related documentation, click [here](#).

## Logic Block Diagram



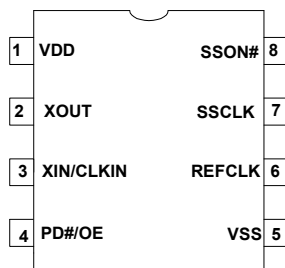
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## Pinouts

Figure 1. 8-pin SOIC/TSSOP pinout

CY25100



## Pin Description

| Pin | Name      | Type   | Description                                                                                                                                                                                                                                                               |
|-----|-----------|--------|---------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 1   | VDD       | Power  | 3.3 V power supply.                                                                                                                                                                                                                                                       |
| 2   | XOUT      | Output | Crystal output. Leave this pin floating if external clock is connected to pin 3.                                                                                                                                                                                          |
| 3   | XIN/CLKIN | Input  | Crystal input or reference clock input.                                                                                                                                                                                                                                   |
| 4   | PD#/OE    | Input  | User has the option of choosing either PD# or OE function.<br>Power Down pin: Active LOW. If PD# = 0, PLL and crystal oscillator circuit are powered down, and outputs are weakly pulled low.<br>Output Enable pin: Active HIGH. If OE = 1, SSCLK and REFCLK are enabled. |
| 5   | VSS       | Power  | Power supply ground.                                                                                                                                                                                                                                                      |
| 6   | REFCLK    | Output | Buffered reference output.                                                                                                                                                                                                                                                |
| 7   | SSCLK     | Output | Spread spectrum clock output.                                                                                                                                                                                                                                             |
| 8   | SSON#     | Input  | Spread spectrum control: Active LOW. 0 = spread on. 1 = spread off.                                                                                                                                                                                                       |

## User Specified Variables

| Pin Function | Input Frequency | Total Crystal Load Capacitance | Output Frequency | Spread Percent (0.5% – 5%, 0.25% granularity) | Reference Output | Power Down or Output Enable |
|--------------|-----------------|--------------------------------|------------------|-----------------------------------------------|------------------|-----------------------------|
| Pin Name     | XIN and XOUT    | XIN and XOUT                   | SSCLK            | SSCLK                                         | REFOUT           | PD#/OE                      |
| Pin#         | 3 and 2         | 3 and 2                        | 7                | 7                                             | 6                | 4                           |
| Unit         | MHz             | pF                             | MHz              | % and Center- or Down-spread                  | On or Off        | Select PD# or OE            |
|              | USER SPECIFIED  | USER SPECIFIED                 | USER SPECIFIED   | USER SPECIFIED                                | USER SPECIFIED   | USER SPECIFIED              |

## Programming Description

### Field Programmable CY25100

The CY25100 is programmed at the package level, and must be programmed prior to installation on a circuit board. Field programmable devices are denoted by an "F" in the ordering code, and are blank when shipped. The CY25100 is Flash technology based, which allows it to be reprogrammed up to 100 times. This allows fast and easy design changes and product updates, and eliminates issues with old and out of date inventory.

Samples and small prototype quantities can be programmed on the CY3672 programmer with the CY3690 (TSSOP package) or CY3691 (SOIC package) socket adapter.

### CY3672 Programmer and CY3690/CY3691 Socket Adapters

The Cypress CY3672 programmer and the CY3690 or CY3691 socket adapter may be used to program field programmable versions of the CY25100. The CY3690 enables users to program the CY25100ZXCF and CY25100ZXIF (TSSOP). CY3691 provides the ability to program the CY25100SXCF and CY25100SXIF (SOIC). The CY3690 and CY3691 are separate orderable items, so the existing users of the CY3672 programmer need to order only the specific socket adapter to program the CY25100.

### Factory Programmable CY25100

Factory programming by Cypress is available for high volume orders. All requests must be submitted to the local Cypress Field Application Engineer (FAE) or sales representative. After the request is processed, you will receive a new part number, samples, and data sheet with the programmed values. This part number is used for additional sample requests and production orders.

## Product Functions

### Input Frequency (XIN, Pin 3 and XOUT, Pin 2)

The input to the CY25100 can be a crystal or a clock. The input frequency range for crystals is 8 to 30 MHz, and for clock signals is 8 to 166 MHz.

### C<sub>XIN</sub> and C<sub>XOUT</sub> (Pin 3 and Pin 2)

The CY25100 has internal load capacitors at Pin 3 (C<sub>XIN</sub>) and Pin 2 (C<sub>XOUT</sub>). C<sub>XIN</sub> always equals C<sub>XOUT</sub>, and they are

programmable from 12 pF to 60 pF, in 0.5 pF increments. This feature eliminates the need for external crystal load capacitors.

The following formula is used to calculate the value of C<sub>XIN</sub> and C<sub>XOUT</sub> for matching the crystal load (C<sub>L</sub>):

$$C_{XIN} = C_{XOUT} = 2C_L - C_P$$

where C<sub>L</sub> is the crystal load capacitor as specified by the crystal manufacturer and C<sub>P</sub> is the parasitic PCB capacitance on each node of the crystal.

For example, if a crystal with C<sub>L</sub> of 16 pF is used, and C<sub>P</sub> is 2 pF, C<sub>XIN</sub> and C<sub>XOUT</sub> are calculated as:

$$C_{XIN} = C_{XOUT} = (2 \times 16) - 2 = 30 \text{ pF}$$

If using a driven reference, set C<sub>XIN</sub> and C<sub>XOUT</sub> to the minimum value 12 pF, connect the reference to XIN/CLKIN, and leave XOUT unconnected.

### Output Frequency (SSCLK, Pin 7)

The modulated frequency at the SSCLK output is produced by synthesizing the input reference clock. The modulation can be stopped by SSON# digital control input (SSON# = HIGH, no modulation). If modulation is stopped, the clock frequency is the nominal value of the synthesized frequency without modulation (spread percentage = 0). The range of synthesized clock is from 3 to 200 MHz.

### Spread Percentage (SSCLK, Pin 7)

The SSCLK spread can be programmed at any percentage value from ±0.25% to ±2.5% for center spread and from -0.5% to -5.0% for down spread.

### Reference Output (REFOUT, Pin 6)

The reference clock output has the same frequency and the same phase as the input clock. This output can be programmed to be enabled (clock on) or disabled (High Z, clock off). If this output is not required, it is recommended that the disabled (High Z, Clock Off) option be selected.

### Modulation Frequency

The modulation frequency is 31.5 kHz for all SSCLK frequencies from 3 to 200 MHz.

### Power Down or Output Enable (PD# or OE, Pin 4)

The part can be programmed to include either PD# or OE function. PD# function powers down the oscillator and PLL. The OE function disables the outputs.

## Absolute Maximum Ratings

Supply Voltage ( $V_{DD}$ ) ..... -0.5 to +7.0 V  
 DC Input Voltage ..... -0.5 V to  $V_{DD} + 0.5$  V  
 Storage Temperature  
 (Non condensing) ..... -55 °C to +125 °C

Junction Temperature ..... -40 °C to +125 °C  
 Data Retention at  $T_j = 125$  °C ..... > 10 years  
 Package Power Dissipation ..... 350 mW  
 Static Discharge Voltage  
 (per MIL-STD-883, Method 3015) .....  $\geq 2000$  V

## Recommended Crystal Specifications

| Parameter  | Description                                              | Comments                                                                    | Min | Typ | Max | Unit     |
|------------|----------------------------------------------------------|-----------------------------------------------------------------------------|-----|-----|-----|----------|
| $f_{NOM}$  | Nominal Crystal Frequency                                | Parallel resonance, fundamental mode, AT cut                                | 8   | —   | 30  | MHz      |
| $C_{LNOM}$ | Nominal Load Capacitance                                 | Internal load caps                                                          | 6   | —   | 30  | pF       |
| $R_1$      | Equivalent Series Resistance (ESR)                       | Fundamental mode                                                            | —   | —   | 25  | $\Omega$ |
| $R_3/R_1$  | Ratio of Third Overtone Mode ESR to Fundamental Mode ESR | Ratio used because typical $R_1$ values are much less than the maximum spec | 3   | —   | —   | —        |
| DL         | Crystal Drive Level                                      | No external series resistor assumed                                         | —   | 0.5 | 2   | mW       |

## Operating Conditions

| Parameter    | Description                                                                                         | Min  | Typ  | Max  | Unit |
|--------------|-----------------------------------------------------------------------------------------------------|------|------|------|------|
| $V_{DD}$     | Supply Voltage                                                                                      | 3.13 | 3.30 | 3.45 | V    |
| $T_A$        | Ambient Commercial Temperature                                                                      | 0    | —    | 70   | °C   |
|              | Ambient Industrial Temperature                                                                      | -40  | —    | 85   | °C   |
| $C_{LOAD}$   | Maximum Load Capacitance at Pin 6 and Pin 7                                                         | —    | —    | 15   | pF   |
| $f_{REF}$    | External Reference Crystal (Fundamental tuned crystals only)                                        | 8    | —    | 30   | MHz  |
|              | External Reference Clock                                                                            | 8    | —    | 166  | MHz  |
| $f_{SSCLK}$  | SSCLK Output Frequency, $C_{LOAD} = 15$ pF                                                          | 3    | —    | 200  | MHz  |
| $f_{REFCLK}$ | REFCLK Output Frequency, $C_{LOAD} = 15$ pF                                                         | 8    | —    | 166  | MHz  |
| $f_{MOD}$    | Spread Spectrum Modulation Frequency                                                                | 30.0 | 31.5 | 33.0 | kHz  |
| $t_{PU}$     | Power Up Time for all $V_{DD}$ 's to reach minimum specified voltage (power ramp must be monotonic) | 0.05 | —    | 500  | ms   |

## DC Electrical Characteristics

| Parameter                              | Description                                 | Condition                                                                                                                                                                      | Min                 | Typ | Max                 | Unit          |
|----------------------------------------|---------------------------------------------|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|---------------------|-----|---------------------|---------------|
| $I_{OH}$                               | Output High Current                         | $V_{OH} = V_{DD} - 0.5\text{ V}$ ,<br>$V_{DD} = 3.3\text{ V}$ (source)                                                                                                         | 10                  | 12  | –                   | mA            |
| $I_{OL}$                               | Output Low Current                          | $V_{OL} = 0.5\text{ V}$ , $V_{DD} = 3.3\text{ V}$ (sink)                                                                                                                       | 10                  | 12  | –                   | mA            |
| $V_{IH}$                               | Input High Voltage                          | CMOS levels, 70% of $V_{DD}$                                                                                                                                                   | $0.7 \times V_{DD}$ | –   | $V_{DD}$            | V             |
| $V_{IL}$                               | Input Low Voltage                           | CMOS levels, 30% of $V_{DD}$                                                                                                                                                   | –                   | –   | $0.3 \times V_{DD}$ | V             |
| $I_{IH}$                               | Input High Current, PD#/OE and SSON# Pins   | $V_{in} = V_{DD}$                                                                                                                                                              | –10                 | –   | 10                  | $\mu\text{A}$ |
| $I_{IL}$                               | Input Low Current, PD#/OE and SSON# Pins    | $V_{in} = V_{SS}$                                                                                                                                                              | –10                 | –   | 10                  | $\mu\text{A}$ |
| $I_{OZ}$                               | Output Leakage Current                      | Three-state output, PD#/OE = 0,<br>output pulldown resistor disabled                                                                                                           | –10                 | –   | 10                  | $\mu\text{A}$ |
| $C_{XIN}$ or $C_{XOUT}$ <sup>[1]</sup> | Programmable Capacitance at Pin 2 and Pin 3 | Capacitance at minimum setting                                                                                                                                                 | –                   | 12  | –                   | pF            |
|                                        |                                             | Capacitance at maximum setting                                                                                                                                                 | –                   | 60  | –                   | pF            |
| $C_{IN}$ <sup>[1]</sup>                | Input Capacitance at Pin 4 and Pin 8        | Input pins excluding XIN and XOUT                                                                                                                                              | –                   | 5   | 7                   | pF            |
| $I_{VDD}$                              | Supply Current                              | $V_{DD} = 3.45\text{ V}$ , $F_{in} = 30\text{ MHz}$ ,<br>$REFCLK = 30\text{ MHz}$ ,<br>$SSCLK = 66\text{ MHz}$ ,<br>$C_{LOAD} = 15\text{ pF}$ ,<br>$PD\#/OE = SSON\# = V_{DD}$ | –                   | 25  | 35                  | mA            |
| $I_{DDS}$                              | Standby Current                             | $V_{DD} = 3.45\text{ V}$ , Device powered down<br>with PD# = 0 V (driven reference<br>pulled down)                                                                             | –                   | 15  | 30                  | $\mu\text{A}$ |

## Thermal Resistance

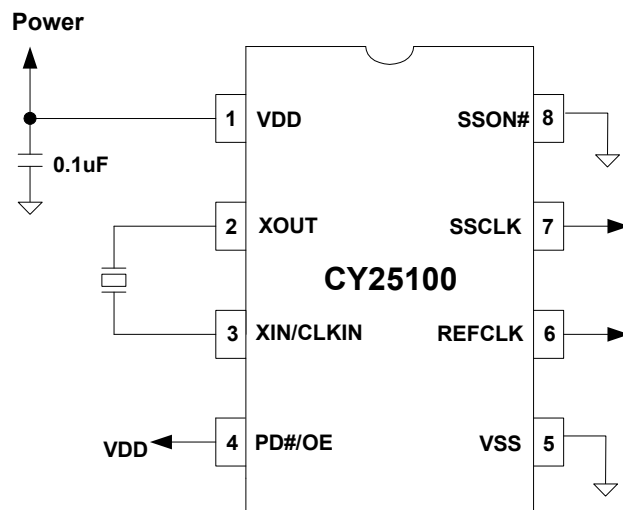
| Parameter <sup>[2]</sup> | Description                                 | Test Conditions                                                                                                                      | 8-pin SOIC | 8-pin TSSOP | Unit                 |
|--------------------------|---------------------------------------------|--------------------------------------------------------------------------------------------------------------------------------------|------------|-------------|----------------------|
| $\theta_{JA}$            | Thermal resistance<br>(junction to ambient) | Test conditions follow standard test<br>methods and procedures for measuring<br>thermal impedance, in accordance with<br>EIA/JESD51. | 134        | 161         | $^{\circ}\text{C/W}$ |
| $\theta_{JC}$            | Thermal resistance<br>(junction to case)    |                                                                                                                                      | 49         | 31          | $^{\circ}\text{C/W}$ |

### Notes

1. Guaranteed by characterization, not 100% tested.
2. These parameters are guaranteed by design and are not tested.

## Application Circuit

Figure 2. Application Circuit Diagram [3, 4, 5]



### Notes

- Because the load capacitors ( $C_{XIN}$  and  $C_{XOUT}$ ) are provided by the CY25100, no external capacitors are needed on the  $X_{IN}$  and  $X_{OUT}$  pins to match the crystal load capacitor ( $C_L$ ). Only a single 0.1-µF bypass capacitor is required on the  $V_{DD}$  pin.
- If an external clock is used, apply the clock to  $X_{IN}$  (pin 3) and leave  $X_{OUT}$  (pin 2) floating (unconnected).
- If  $SSON\#$  (pin 8) is LOW ( $V_{SS}$ ), the frequency modulation is on at  $SSCLK$  (pin 7).

## AC Electrical Characteristics

The AC Electrical Characteristics for part CY25100 is as follows. [6]

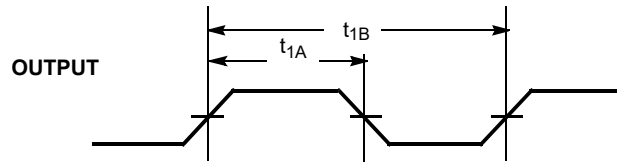
| Parameter      | Description                               | Condition                                                                                                                | Min | Typ | Max | Unit |
|----------------|-------------------------------------------|--------------------------------------------------------------------------------------------------------------------------|-----|-----|-----|------|
| DC             | Output Duty Cycle                         | SSCLK, Measured at $V_{DD}/2$                                                                                            | 45  | 50  | 55  | %    |
|                | Output Duty Cycle                         | REFCLK, Measured at $V_{DD}/2$ ,<br>Duty Cycle of CLKIN = 50% at input bias                                              | 40  | 50  | 60  | %    |
| SR1            | Rising Edge Slew Rate                     | SSCLK from 3 to 100 MHz;<br>REFCLK from 3 to 100 MHz;<br>20%–80% of $V_{DD}$                                             | 0.7 | 1.1 | 3.6 | V/ns |
| SR2            | Falling Edge Slew Rate                    | SSCLK from 3 to 100 MHz;<br>REFCLK from 3 to 100 MHz;<br>80%–20% of $V_{DD}$                                             | 0.7 | 1.1 | 3.6 | V/ns |
| SR3            | Rising Edge Slew Rate                     | SSCLK from 100 to 200 MHz;<br>REFCLK from 100 to 166 MHz;<br>20%–80% of $V_{DD}$                                         | 1.0 | 1.6 | 4.0 | V/ns |
| SR4            | Falling Edge Slew Rate                    | SSCLK from 100 to 200 MHz;<br>REFCLK from 100 to 166 MHz;<br>80%–20% of $V_{DD}$                                         | 1.2 | 1.6 | 4.0 | V/ns |
| $t_{CCJ1}$ [7] | Cycle-to-Cycle Jitter,<br>SSCLK (Pin 7)   | CLKIN = SSCLK = 166 MHz,<br>2% spread, REFCLK off                                                                        | –   | 90  | 120 | ps   |
|                |                                           | CLKIN = SSCLK = 66 MHz,<br>2% spread, REFCLK off                                                                         | –   | 100 | 130 | ps   |
|                |                                           | CLKIN = SSCLK = 33 MHz,<br>2% spread, REFCLK off                                                                         | –   | 130 | 170 | ps   |
| $t_{CCJ2}$ [7] | Cycle-to-Cycle Jitter,<br>SSCLK (Pin 7)   | CLKIN = SSCLK = 166 MHz,<br>2% spread, REFCLK on                                                                         | –   | 100 | 130 | ps   |
|                |                                           | CLKIN = SSCLK = 66 MHz,<br>2% spread, REFCLK on                                                                          | –   | 105 | 140 | ps   |
|                |                                           | CLKIN = SSCLK = 33 MHz,<br>2% spread, REFCLK on                                                                          | –   | 200 | 260 | ps   |
| $t_{CCJ3}$ [7] | Cycle-to-Cycle Jitter,<br>REFCLK (Pin 6)  | CLKIN = SSCLK = 166 MHz,<br>2% spread, REFCLK on                                                                         | –   | 80  | 100 | ps   |
|                |                                           | CLKIN = SSCLK = 66 MHz,<br>2% spread, REFCLK on                                                                          | –   | 100 | 130 | ps   |
|                |                                           | CLKIN = SSCLK = 33 MHz,<br>2% spread, REFCLK on                                                                          | –   | 135 | 180 | ps   |
| $t_{STP}$      | Power down Time (pin 4 = PD#)             | Time from falling edge on PD# to<br>stopped outputs (Asynchronous)                                                       | –   | 150 | 350 | ns   |
| $t_{OE1}$      | Output Disable Time (pin 4 = OE)          | Time from falling edge on OE to<br>stopped outputs (Asynchronous)                                                        | –   | 150 | 350 | ns   |
| $t_{OE2}$      | Output Enable Time (pin 4 = OE)           | Time from rising edge on OE to<br>outputs at a valid frequency<br>(Asynchronous)                                         | –   | 150 | 350 | ns   |
| $t_{PU1}$      | Power Up Time, Crystal is used            | Time from rising edge on PD# to<br>outputs at valid frequency<br>(Asynchronous)                                          | –   | 3.5 | 5   | ms   |
| $t_{PU2}$      | Power Up Time, Reference clock<br>is used | Time from rising edge on PD# to<br>outputs at valid frequency<br>(Asynchronous), reference clock at<br>correct frequency | –   | 2   | 3   | ms   |

### Notes

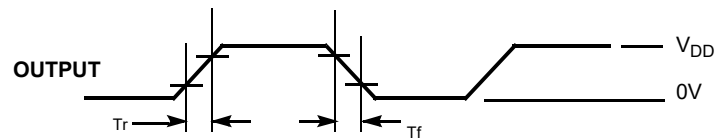
6. Guaranteed by characterization, not 100% tested.
7. Jitter is configuration dependent. Actual jitter is dependent on XIN jitter and edge rate, number of active outputs, output frequencies, spread percentage, temperature, and output load.

## Switching Waveforms

**Figure 3. Duty Cycle Timing ( $DC = t_{1A}/t_{1B}$ )**



**Figure 4. Output Rise/Fall Time (SSCLK and REFCLK)**

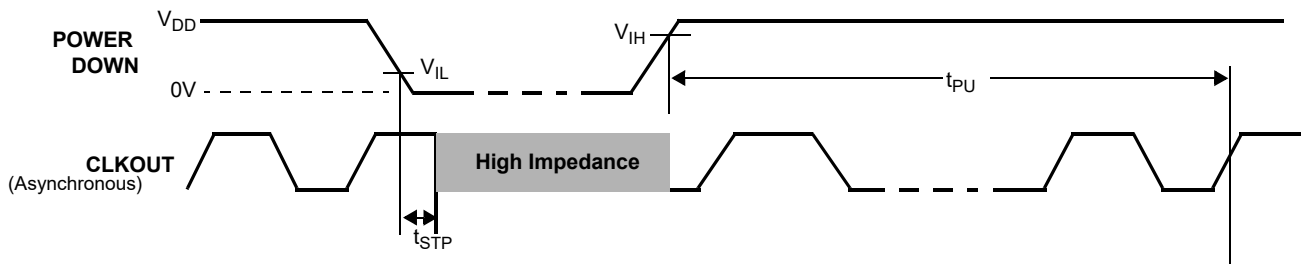


Output Rise time ( $T_r$ ) =  $(0.6 \times V_{DD})/SR1$  (or SR3)

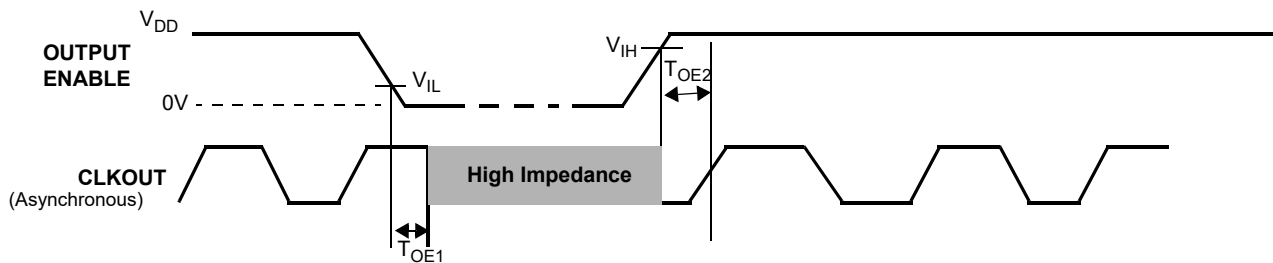
Output Fall time ( $T_f$ ) =  $(0.6 \times V_{DD})/SR2$  (or SR4)

Refer to AC Electrical Characteristics table for SR (Slew Rate) values.

**Figure 5. Power Down and Power Up Timing**

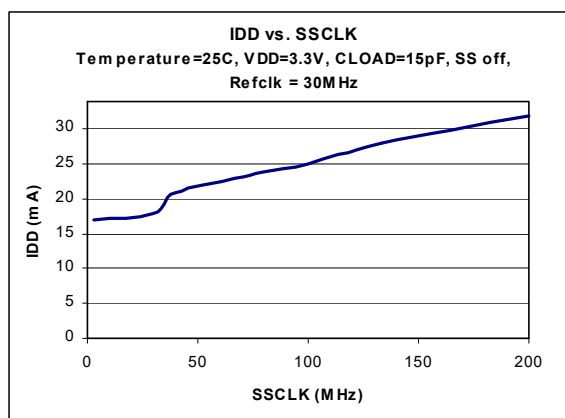
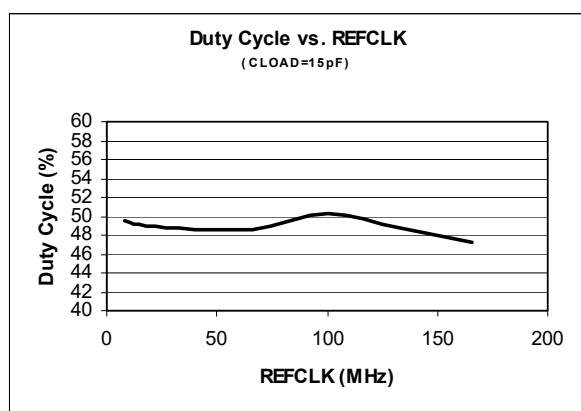
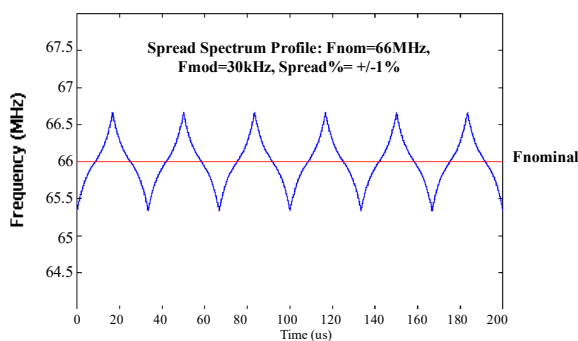
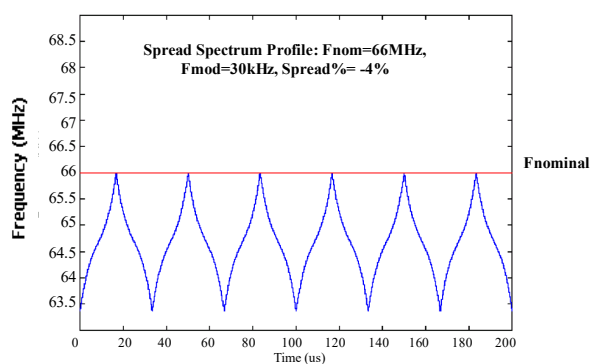
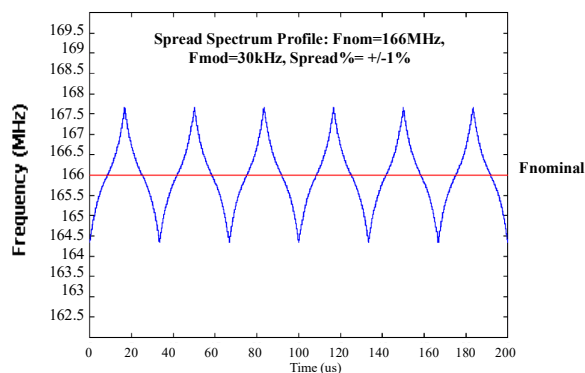
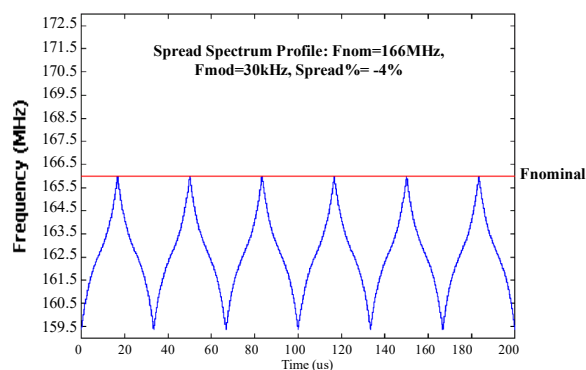


**Figure 6. Output Enable/Disable Timing**



## Informational Graphs

The Informational Graphs are as follows. [8]

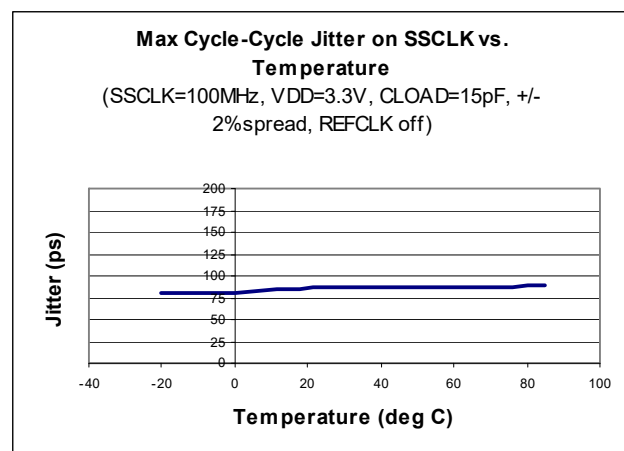
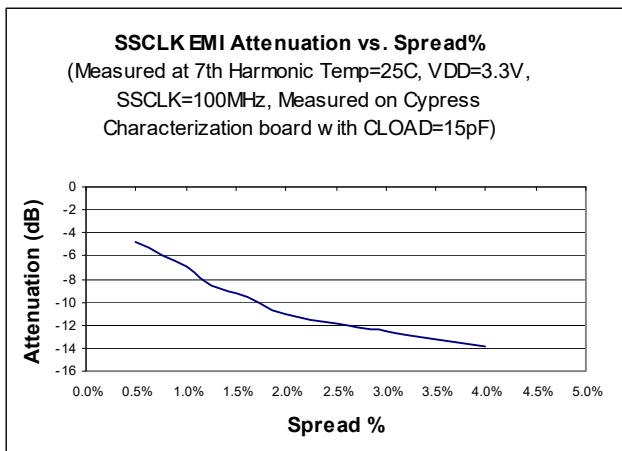
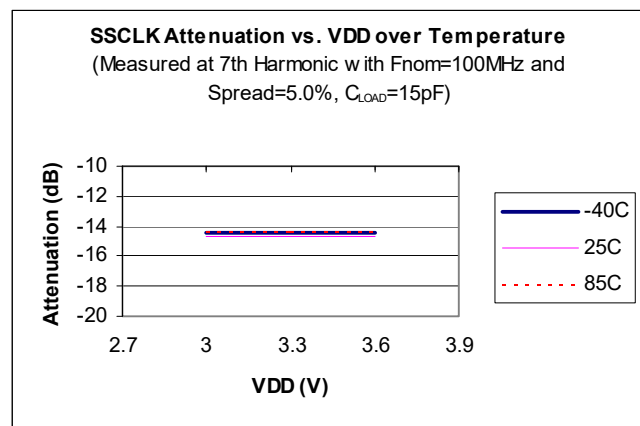
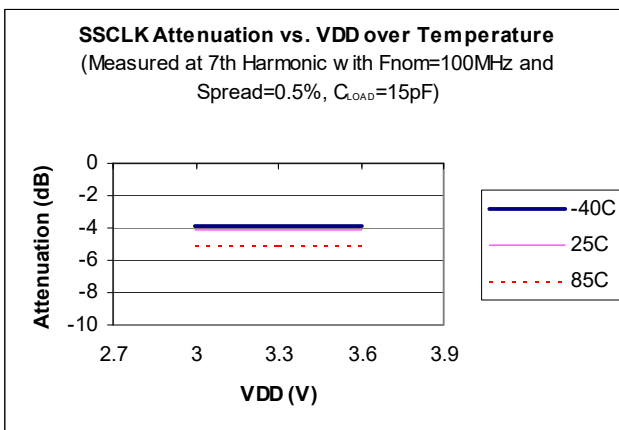
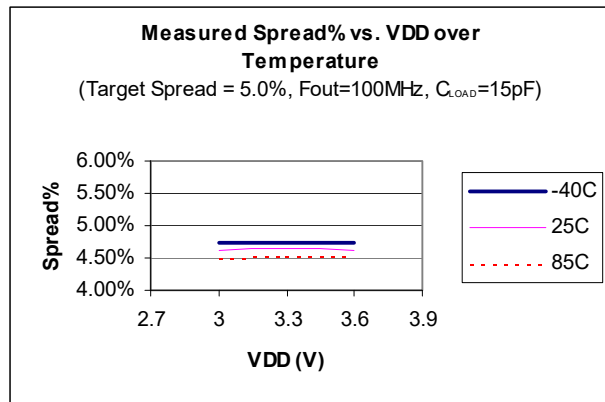
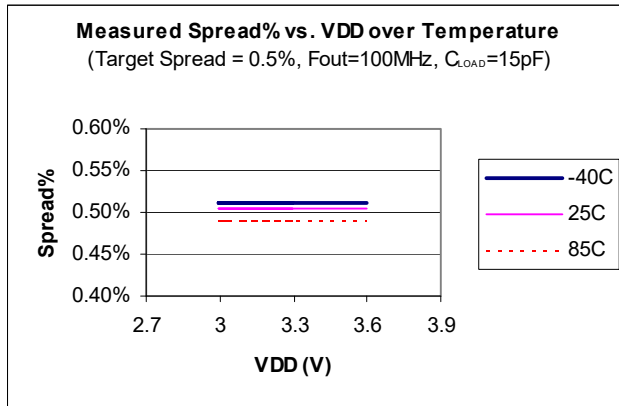


### Note

8. The Informational Graphs are meant to convey the typical performance levels. No performance specifications is implied or guaranteed. Refer to [DC Electrical Characteristics on page 6](#) and [AC Electrical Characteristics on page 8](#) for device specifications.

## Informational Graphs (continued)

The Informational Graphs are as follows. [8]



## Ordering Information

| Ordering Code     | Package Description         | Product Flow                |
|-------------------|-----------------------------|-----------------------------|
| <b>Pb-free</b>    |                             |                             |
| CY25100SXCF       | 8-pin SOIC                  | Commercial, 0 °C to 70 °C   |
| CY25100SXCFT      | 8-pin SOIC – Tape and Reel  | Commercial, 0 °C to 70 °C   |
| CY25100SXIF       | 8-pin SOIC                  | Industrial, –40 °C to 85 °C |
| CY25100SXIFT      | 8-pin SOIC – Tape and Reel  | Industrial, –40 °C to 85 °C |
| CY25100ZXCf       | 8-pin TSSOP                 | Commercial, 0 °C to 70 °C   |
| CY25100ZXCFT      | 8-pin TSSOP – Tape and Reel | Commercial, 0 °C to 70 °C   |
| CY25100ZXIF       | 8-pin TSSOP                 | Industrial, –40 °C to 85 °C |
| CY25100ZXIFT      | 8-pin TSSOP – Tape and Reel | Industrial, –40 °C to 85 °C |
| <b>Programmer</b> |                             |                             |
| CY3675-CLKMAKER1  | Programmer                  |                             |

Some product offerings are factory programmed customer specific devices with customized part numbers. The Possible Configurations table shows the available device types, but not complete part numbers. Contact your local Cypress FAE or Sales Representative for more information.

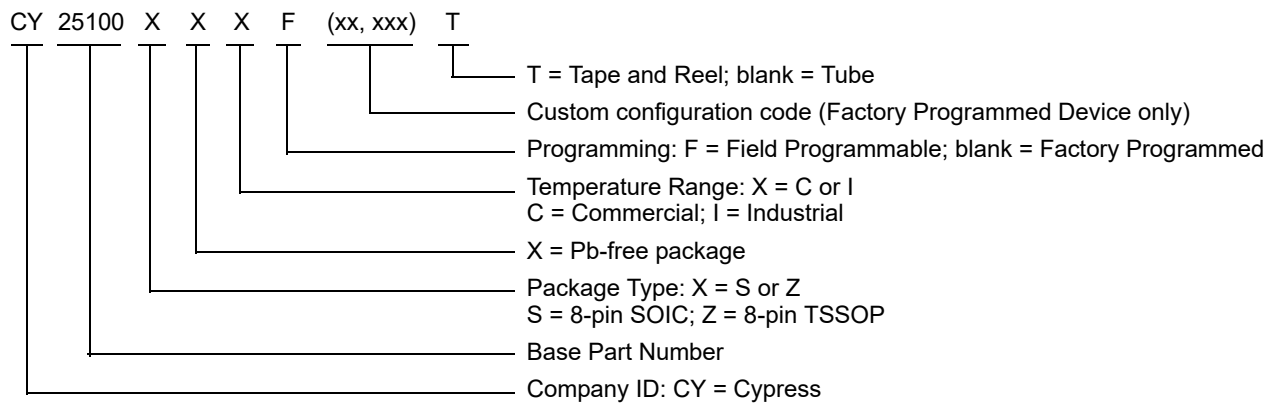
## Possible Configurations

| Ordering Code                    | Package Description         | Product Flow                |
|----------------------------------|-----------------------------|-----------------------------|
| CY25100Zlxxx <sup>[9, 10]</sup>  | 8-pin TSSOP                 | Industrial, –40 °C to 85 °C |
| CY25100ZlxxxT <sup>[9, 10]</sup> | 8-pin TSSOP – Tape and Reel | Industrial, –40 °C to 85 °C |
| <b>Pb-free</b>                   |                             |                             |
| CY25100SXCxx <sup>[9]</sup>      | 8-pin SOIC                  | Commercial, 0 °C to 70 °C   |
| CY25100SXCxxT <sup>[9]</sup>     | 8-pin SOIC – Tape and Reel  | Commercial, 0 °C to 70 °C   |
| CY25100SXlxxx <sup>[9]</sup>     | 8-pin SOIC                  | Industrial, –40 °C to 85 °C |
| CY25100SXlxxxT <sup>[9]</sup>    | 8-pin SOIC – Tape and Reel  | Industrial, –40 °C to 85 °C |
| CY25100ZXCxx <sup>[9]</sup>      | 8-pin TSSOP                 | Commercial, 0 °C to 70 °C   |
| CY25100ZXCxxT <sup>[9]</sup>     | 8-pin TSSOP – Tape and Reel | Commercial, 0 °C to 70 °C   |
| CY25100ZXlxx <sup>[9]</sup>      | 8-pin TSSOP                 | Industrial, –40 °C to 85 °C |
| CY25100ZXlxxT <sup>[9]</sup>     | 8-pin TSSOP – Tape and Reel | Industrial, –40 °C to 85 °C |

### Note

9. Ordering codes with "xxx" or "xx" are factory-programmed configurations. "xxx" or "xx" denotes the specific device configuration. "w" denotes the revision. Factory programming is available for high-volume orders. For more details, contact your local Cypress field application engineer or Cypress Sales Representative.

10. Not recommended for new designs. New designs should use Pb-free devices.

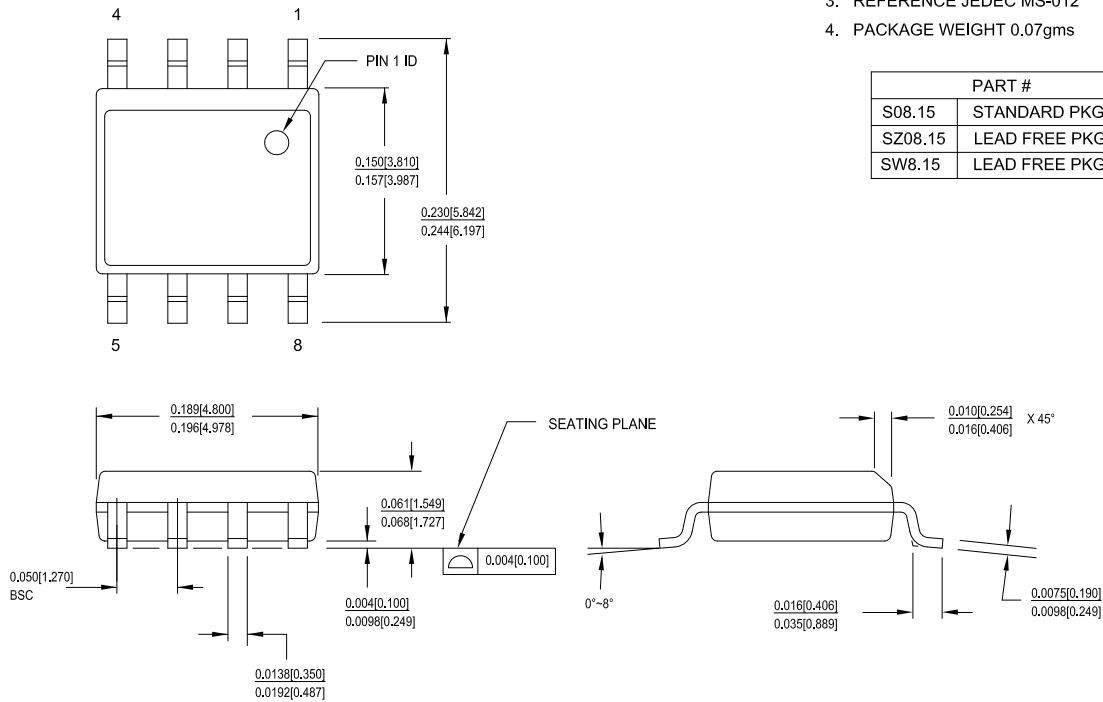
**Ordering Code Definitions**


## Package Diagrams

**Figure 7. 8-pin SOIC (150 Mils) S08.15/SZ08.15/SW815 Package Outline, 51-85066**

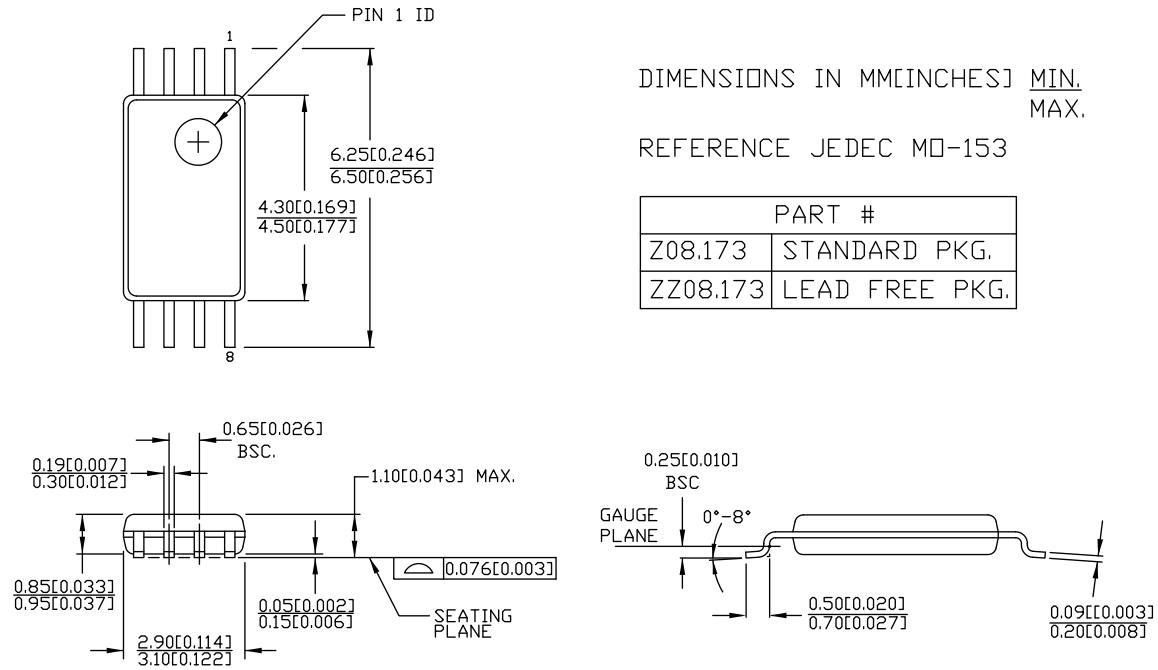
1. DIMENSIONS IN INCHES[MM] MIN.  
MAX.
2. PIN 1 ID IS OPTIONAL,  
ROUND ON SINGLE LEADFRAME  
RECTANGULAR ON MATRIX LEADFRAME
3. REFERENCE JEDEC MS-012
4. PACKAGE WEIGHT 0.07gms

| PART #  |               |
|---------|---------------|
| S08.15  | STANDARD PKG  |
| SZ08.15 | LEAD FREE PKG |
| SW8.15  | LEAD FREE PKG |



51-85066 \*I

**Package Diagrams** (continued)

**Figure 7. 8-pin TSSOP (4.40 mm Body) Z08.173/ZZ08.173 Package Outline, 51-85093**

 DIMENSIONS IN MM[INCHES] MIN.  
MAX.

REFERENCE JEDEC MO-153

| PART #   |                |
|----------|----------------|
| Z08.173  | STANDARD PKG.  |
| ZZ08.173 | LEAD FREE PKG. |

51-85093 \*E

## Acronyms

| Acronym | Description                                |
|---------|--------------------------------------------|
| DC      | Direct Current                             |
| EMI     | Electromagnetic Interference               |
| ESR     | Equivalent Series Resistance               |
| FAE     | Field Application Engineer                 |
| JEDEC   | Joint Electron Devices Engineering Council |
| OE      | Output Enable                              |
| PCB     | Printed Circuit Board                      |
| PD      | Power Down                                 |
| PLL     | Phase Locked Loop                          |
| SOIC    | Small Outline Integrated Circuit           |
| SSC     | Spread Spectrum Clock                      |
| SSCG    | Spread Spectrum Clock Generator            |
| TSSOP   | Thin Shrunk Small Outline Package          |

## Document Conventions

### Units of Measure

| Symbol | Unit of Measure |
|--------|-----------------|
| °C     | degree Celsius  |
| kHz    | kilohertz       |
| MHz    | megahertz       |
| μA     | microampere     |
| μF     | microfarad      |
| mA     | milliampere     |
| mm     | millimeter      |
| ms     | millisecond     |
| mW     | milliwatt       |
| ns     | nanosecond      |
| Ω      | ohm             |
| %      | percent         |
| pF     | picofarad       |
| ps     | picosecond      |
| V      | volt            |

## Document History Page

| Document Title: CY25100, Field and Factory Programmable Spread Spectrum Clock Generator for EMI Reduction<br>Document Number: 38-07499 |         |                 |                 |                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                 |
|----------------------------------------------------------------------------------------------------------------------------------------|---------|-----------------|-----------------|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| Rev.                                                                                                                                   | ECN No. | Orig. of Change | Submission Date | Description of Change                                                                                                                                                                                                                                                                                                                                                                                                                                                                                           |
| **                                                                                                                                     | 126578  | CKN             | 06/27/2003      | New data sheet.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                 |
| *A                                                                                                                                     | 128753  | IJATMP          | 08/29/2003      | Updated <a href="#">Programming Description</a> :<br>Added <a href="#">Field Programmable CY25100</a> .<br>Added CyberClocks™ Online Software.<br>Added <a href="#">CY3672 Programmer and CY3690/CY3691 Socket Adapters</a> .<br>Added <a href="#">Factory Programmable CY25100</a> .<br>Removed "Custom Configuration Request Procedure".<br>Updated <a href="#">Ordering Information</a> :<br>Updated part numbers.<br>Added Note 9 and referred the same note in "Part Number" column.                       |
| *B                                                                                                                                     | 130342  | RGL             | 12/02/2003      | Updated <a href="#">Application Circuit</a> :<br>Updated <a href="#">Figure 2</a> .<br>Updated <a href="#">Ordering Information</a> :<br>No change in part numbers.<br>Updated details in "Package Description" column corresponding to MPNs CY3690 and CY3691.<br>Updated <a href="#">Package Diagrams</a> :<br>spec 51-85066 – Changed revision from *B to *C.<br>spec 51-85093 – Changed revision from ** to *A.                                                                                             |
| *C                                                                                                                                     | 204121  | RGL             | 02/11/2004      | Added Industrial Temperature Range related information in all instances across the document.<br>Updated <a href="#">Ordering Information</a> :<br>Updated part numbers.<br>Updated Note 9.                                                                                                                                                                                                                                                                                                                      |
| *D                                                                                                                                     | 215392  | RGL             | 03/31/2004      | Updated <a href="#">Ordering Information</a> :<br>Updated part numbers.                                                                                                                                                                                                                                                                                                                                                                                                                                         |
| *E                                                                                                                                     | 2513909 | AESA            | 06/10/2008      | Updated <a href="#">Ordering Information</a> :<br>Updated part numbers.<br>Replaced "Lead free" with "Pb-Free".<br>Added Note 10 and referred the same note in corresponding MPNs.<br>Added "Pb-Free" in header.<br>Updated details in "Package Description" column (Removed Pb-Free).<br>Updated to new template.                                                                                                                                                                                              |
| *F                                                                                                                                     | 2601881 | KVM / PYRS      | 11/06/2008      | Updated <a href="#">AC Electrical Characteristics</a> :<br>Changed minimum value of SR3 parameter from 1.2 V/ns to 1.0 V/ns.<br>Updated <a href="#">Ordering Information</a> :<br>Updated part numbers.<br>Removed reference of Note 9 from Parameter column.<br>Referred Note 9 in 'xxx' parts.                                                                                                                                                                                                                |
| *G                                                                                                                                     | 2742910 | KVM             | 07/23/2009      | General text cleanup across the document.<br>Replaced "CY3672 FTG" with "CY3672" in all instances across the document.<br>Removed "Benefits".<br>Updated <a href="#">Pin Description</a> :<br>Added a column "Type" and added corresponding details of all pins.<br>Updated <a href="#">Programming Description</a> :<br>Updated CyberClocks™ Online Software:<br>Updated description.<br>Updated <a href="#">Product Functions</a> :<br>Updated <a href="#">Modulation Frequency</a> :<br>Updated description. |

**Document History Page** (continued)

| Document Title: CY25100, Field and Factory Programmable Spread Spectrum Clock Generator for EMI Reduction<br>Document Number: 38-07499 |         |                 |                 |                                                                                                                                                                                                                                                                                                                                                                                                                                                                          |
|----------------------------------------------------------------------------------------------------------------------------------------|---------|-----------------|-----------------|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| Rev.                                                                                                                                   | ECN No. | Orig. of Change | Submission Date | Description of Change                                                                                                                                                                                                                                                                                                                                                                                                                                                    |
| *G (cont.)                                                                                                                             | 2742910 | KVM             | 07/23/2009      | Updated <a href="#">DC Electrical Characteristics</a> :<br>Added minimum values for $I_{IH}$ and $I_{IL}$ parameters.<br>Updated details in "Condition" column corresponding to $I_{OZ}$ parameter.<br>Updated <a href="#">AC Electrical Characteristics</a> :<br>Standardized timing parameter names to upper case in "Parameter" column.<br>Updated <a href="#">Ordering Information</a> :<br>Updated part numbers.<br>Updated Note 9.<br>Updated Note 10.             |
| *H                                                                                                                                     | 2897317 | KVM             | 03/22/2010      | Updated <a href="#">Ordering Information</a> :<br>Updated part numbers.<br>Added <a href="#">Possible Configurations</a> :<br>Moved 'xxx' parts under Possible Configurations.<br>Updated <a href="#">Package Diagrams</a> :<br>spec 51-85066 – Changed revision from *C to *D.<br>spec 51-85093 – Changed revision from *A to *B.                                                                                                                                       |
| *I                                                                                                                                     | 3366141 | PURU            | 09/12/2011      | Updated <a href="#">Logic Block Diagram</a> .<br>Updated <a href="#">Ordering Information</a> :<br>No change in part numbers.<br>Added <a href="#">Ordering Code Definitions</a> .<br>Updated <a href="#">Package Diagrams</a> :<br>spec 51-85066 – Changed revision from *D to *E.<br>spec 51-85093 – Changed revision from *B to *C.<br>Added <a href="#">Acronyms</a> and <a href="#">Units of Measure</a> .<br>Updated to new template.<br>Completing Sunset Review. |
| *J                                                                                                                                     | 4108421 | CINM            | 08/30/2013      | Updated <a href="#">Package Diagrams</a> :<br>spec 51-85066 – Changed revision from *E to *F.<br>spec 51-85093 – Changed revision from *C to *D.<br>Updated to new template.<br>Completing Sunset Review.                                                                                                                                                                                                                                                                |
| *K                                                                                                                                     | 4581659 | TAVA            | 11/28/2014      | Updated <a href="#">Functional Description</a> :<br>Added "For a complete list of related documentation, click <a href="#">here</a> ." at the end.<br>Updated <a href="#">Package Diagrams</a> :<br>spec 51-85093 – Changed revision from *D to *E.                                                                                                                                                                                                                      |
| *L                                                                                                                                     | 5516747 | PSR / PAWK      | 11/10/2016      | Updated <a href="#">Programming Description</a> :<br>Removed "CyberClocks™ Online Software".<br>Added <a href="#">Thermal Resistance</a> .<br>Updated <a href="#">Package Diagrams</a> :<br>spec 51-85066 – Changed revision from *F to *H.<br>Updated to new template.<br>Completing Sunset Review.                                                                                                                                                                     |
| *M                                                                                                                                     | 6015682 | PAWK            | 02/01/2018      | Updated <a href="#">Ordering Information</a> :<br>Updated part numbers.<br>Updated <a href="#">Package Diagrams</a> :<br>spec 51-85066 – Changed revision from *H to *I.<br>Updated to new template.                                                                                                                                                                                                                                                                     |

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